

10/656,698

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	0	"337"/\$.ccls. and fuse and pcb and (heater (heating adj (element resistor)))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/05/13 10:44
L2	502	"337"/\$.ccls. and fuse and (heater (heating adj (element resistor)))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/05/13 10:45
L3	40	2 and substrate	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/05/13 10:48
L4	4	2 and (printed adj circuit adj board)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/05/13 10:53
L5	15	2 and (circuit adj board)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/05/13 10:54
L6	148	(337/184,183).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/05/13 10:58
L7	816	((148/400) or (420/559,561,562, 577)).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/05/13 12:34
L8	0	("7and(fusefusiblefusing)").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/05/13 12:34

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L9	69	7 and (fuse fusible fusing)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/05/13 12:35
L10	412	7 and (((Sn-Bi) (Sn near1 Bi)) (bismuth near\$1 tin))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/05/13 12:37
L11	58	9 and 10	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/05/13 12:37
S6	10	((bi-sn) (bismuth-tin)) and ((thermal temperature) adj fuse)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/05/11 17:08
S7	4	((bi-sn) (bismuth-tin)) and "337"/\$. ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/05/11 17:10
S8	185	((bi-sn) (bismuth-tin) (bismuth and tin)) and (binary adj alloy)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/05/11 17:26
S9	0	S8 and "337"/\$.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/05/11 17:12
S10	15	S8 and fuse	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/05/11 17:12

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S11	118	((bi-sn) (bismuth-tin) (bismuth and tin)) and "337"/\$.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/05/11 17:59
S12	202	sn-bi adj alloy	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/05/11 17:59
S13	0	S12 and "337"/\$.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/05/11 18:00
S14	515	(bismuth near1 tin) adj alloy	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/05/11 18:02
S15	3	S14 and "337"/\$.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/05/11 18:00
S16	354	(bi near1 sn) adj alloy	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/05/11 18:02
S17	9	S16 and "337"/\$.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/05/11 18:03